

### Description

The MO5358 is a ±50 ppb precision MEMS Super-TC-MO engineered for best dynamic performance. It is ideal for high reliability telecom, wireless and networking, industrial, precision GNSS and audio/video applications.

Leveraging KDS's unique DualMEMS<sup>TM</sup> temperature sensing and TurboCompensation<sup>TM</sup> technologies, the MO5358 delivers the best dynamic performance for timing stability in the presence of environmental stressors due to air flow, temperature perturbation, vibration, shock and electromagnetic interference. This device also integrates multiple on-chip regulators to filter power supply noise, eliminating the need for a dedicated external LDO.

The MO5358 offers three device configurations that can be ordered with the associated ordering codes for:

- 1) TC-MO with non-pullable output frequency,
- VCTC-MO allowing voltage control of output frequency,
- DCTC-MO enabling digital control of the output frequency using an I<sup>2</sup>C interface, pullable to 5 ppt (parts per trillion) resolution.

The MO5358 can be factory programmed for any combination of frequency, stability, voltage, and pull range. Programmability enables designers to optimize the clock configuration while eliminating long lead time and customization costs associated with quartz devices where each frequency is custom built.

Refer to Manufacturing Guideline for proper reflow profile and PCB cleaning recommendations to ensure best performance.

# **Block Diagram**

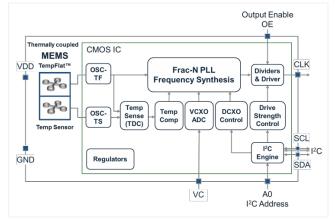


Figure 1. MO5358 Block Diagram

#### **Features**

- Any frequency between 1 MHz and 60 MHz in 1 Hz steps
- Factory programmable options for low lead time
- Best dynamic stability under airflow, thermal shock
  - ±50 ppb over-temperature stability
  - ±1 ppb/°C frequency slope (ΔF/ΔT)
  - 3e-11 ADEV at 10 second averaging time
- 0°C to +70°C operating temperature
- No activity dips or micro jumps
- Resistant to shock, vibration and board bending
- On-chip regulators eliminate the need for external LDOs
- Digital frequency pulling (DCTC-MO) via I<sup>2</sup>C
  - Digital control of output frequency and pull range
  - Up to ±3200 ppm pull range
  - Frequency pull resolution down to 5 ppt
- **■** +2.5V, +2.8V, +3.0V and +3.3V supply voltage
- LVCMOS or clipped sinewave output
- RoHS and REACH compliant
- Pb-free, Halogen-free and Antimony-free

# **Applications**

- 4G/5G radio, Small cell
- IEEE 1588 boundary and grandmaster clocks
- Synchronous Ethernet
- Optical transport SONET/SDH, OTN, Stratum 3
- DOCSIS 3.x remote PHY
- GPS disciplined oscillators
- Precision GNSS systems
- Test and measurement

# 5.0 x 3.2 mm<sup>2</sup> Package Pinout

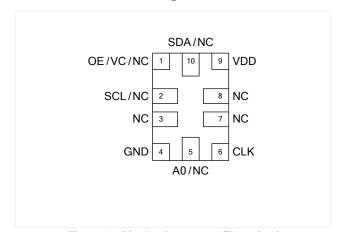
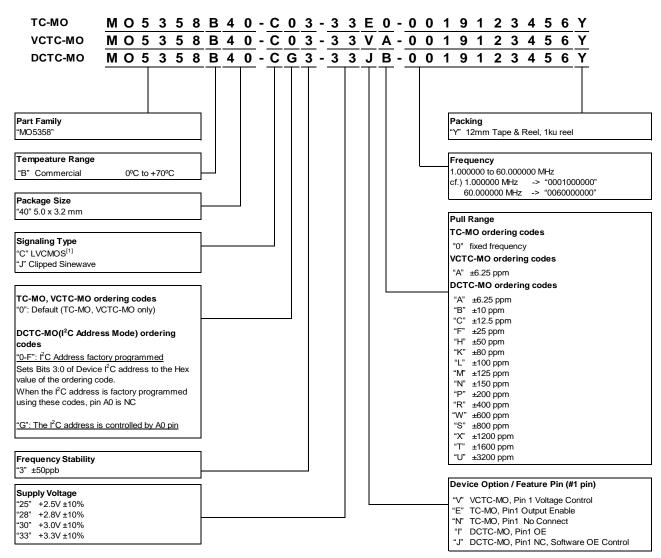


Figure 2. Pin Assignments (Top view) (Refer to Table 11 for Pin Descriptions)



### **Ordering Information**



#### Notes:

<sup>1. &</sup>quot;C" corresponds to the default rise/fall time for LVCMOS output as specified in Table 1 (Electrical Characteristics). Contact KDS for other rise/fall time options for best EMI.



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# **Electrical Characteristics**

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at +25°C and +3.3V Vdd

**Table 1. Output Characteristics** 

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition	
			Frequenc	y Coverag	е		
Output Frequency Range	F	1	_	60	MHz		
			Tempera	ture Range	е	,	
Operating Temperature Range	T_use	0	_	+70	°C	Commercial, ambient temperature	
		Clipped S	inewave O	utput Char	acteristics		
Output Voltage Swing	V_out	+0.8	-	+1.2	٧	Clipped sinewave output, 10kΩ    10 pF±10%	
Rises/Fall Time	Tr, Tf	-	3.5	4.6	ns	20% - 80% Vdd, F_nom = 19.2 MHz	
			Frequen	cy Stability	/		
Initial Tolerance	F_init	-0.5	-	+0.5	ppm	Initial frequency at +25°C inclusive of solder-down shift at 48 hours after 2 reflows	
Supply Voltage Sensitivity	F_Vdd	-2.5	±0.5	+2.5	ppb	Vdd ±5%	
Output Load Sensitivity	F_load	-0.4	±0.05	+0.4	ppb	LVCMOS output, 15 pF ±10%. Clipped sinewave output, $10k\Omega \parallel 10 pF \pm 10\%$	
Frequency Stability over Temperature	F_stab	-50	_	+50	ppb	Referenced to (max frequency+ minimum frequency)/2 over the specified temperature range, Vc = Vdd/2 for VCTC-MO	
Frequency vs. Temperature Slope	ΔΕ/ΔΤ	-	±0.9	±2	ppb/°C	0 to +70°C	
Dynamic Frequency Change during Temperature Ramp	F_dynamic	-0.02	±0.008	+0.02	ppb/s	0.5°C/min temperature ramp rate	
24-hour holdover stability	F_24_Hold	-0.15	-	+0.15	ppm	Inclusive of over-temp frequency variation	
Hysteresis Over Temperature	F_hys	-	±10	_	ppb	0 to +70°C , 0.5°C/min ramp rate,	
One-Day Aging	F_1d	-	±1	-	ppb	At +25°C, after 30-days of continued operation. Aging is measured with respect to day 31	
One-Year Aging	F_1y	-	±0.3	-	ppm	At +25°C, after 2-days of continued operation. Aging is	
20-Year Aging	F_20y	_	±0.5	_	ppm	measured with respect to day 3	
		LVC	MOS Outpu	ut Charact	eristics		
Duty Cycle	DC	45	-	55	%		
Rise/Fall Time	Tr, Tf	0.8	1.2	1.9	ns	10% - 90% Vdd	
Output Voltage High	VOH	90%	-	-	Vdd	I <sub>OH</sub> = +3 mA	
Output Voltage Low	VOL	-	-	10%	Vdd	l <sub>OL</sub> = -3 mA	
Start-up Characteristics							
Start-up Time	T_start	-	2.5	3.5	ms	Time to first pulse, measured from the time Vdd reaches 90% of its final value.  Vdd ramp time = 100 µs from 0V to Vdd.	
Output Enable Time	T_oe	-	-	680	ns	F_nom = 10 MHz, See Timing Diagrams section below.	
First Pulse Accuracy	T_stability	-	5	45	ms	Time to first accurate pulse within rated stability, measured from the time Vdd reaches 90% of its final value. Vdd ramp time = 100 $\mu s$	



### **Table 2. DC Characteristics**

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition		
Supply Voltage								
		+2.25	+2.5	+2.75	V			
Supply Voltage	Vdd	+2.52	+2.8	+3.08	V	Contact KDS for +2.25V to +3.63V continuous supply		
Supply Voltage	vuu	+2.7	+3.0	+3.3	V	voltage support		
		+2.97	+3.3	+3.63	V			
			Current Co	onsumption	1			
Comment Comments	ldd	-	+44	+53	mA	F = 19.2 MHz, No Load, TC-MO ,DCTC-MO		
Current Consumption		_	+48	+57	mA	F = 19.2 MHz, No Load, VCTC-MO		
OE Disable Current	l_od	1	+43	+51	mA	OE = GND, output weakly pulled down , TC-MO, DCTC-MO		
		_	+47	+55	mA	OE = GND, output weakly pulled down , VCTC-MO		

#### **Table 3. Input Characteristics**

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
		In	put Charac	teristics -	OE Pin	•
Input Impedance	Z_in	75	-	_	kΩ	Internal pull up to Vdd
Input High Voltage	VIH	70%	-	-	Vdd	
Input Low Voltage	VIL	-	-	30%	Vdd	
	Freq	uency Tur	ning Range	- Voltage	Control or I <sup>2</sup>	C mode
		±6.25	-	_	ppm	VCTC-MO mode. Contact KDS for ±12.5 and ±25 ppm.
Pull Range	PR	±6.25 ±10 ±12.5 ±25 ±50 ±80 ±100 ±125 ±150 ±200 ±400 ±600 ±1200 ±1600 ±3200	-	-	ppm	DCTC-MO mode
Absolute Pull Range <sup>[2]</sup>	APR	±5.2	-	-	ppm	DCTC-MO, VCTC-MO for PR = ±6.25 ppm
Upper Control Voltage	VC_U	90%	-	-	Vdd	VCTC-MO mode
Lower Control Voltage	VC_L	-	-	10%	Vdd	VCTC-MO mode
Control Voltage Input Impedance	VC_z	8	-	_	ΜΩ	VCTC-MO mode
Control Voltage Input Bandwidth	VC_bw	-	10	-	kHz	VCTC-MO mode
Frequency Control Polarity	F_pol		Positive			VCTC-MO mode
Pull Range Linearity	PR_lin	_	0.5	1.0	%	VCTC-MO mode
	I <sup>2</sup> C Interfa	ace Charac	cteristics, 2	00 Ohm, 5	50 pF (Max I	<sup>2</sup> C Bus Load)
		_	100	_	kHz	-40 to +105°C
Bus Frequency	F_I2C	_	400	_	kHz	-40 to +105°C
		_	1000	_	kHz	-40 to +85°C
Input Voltage Low	VIL_I2C	_	-	30%	Vdd	DCTC-MO mode
Input Voltage High	VIH_I2C	70%	-	_	Vdd	DCTC-MO mode
Output Voltage Low	VOL_I2C	-	-	+0.4	V	DCTC-MO mode
Input Leakage current	lι	+0.5	-	+24	μА	0.1 Vdd <vout<0.9vdd. 200="" current="" dctc-mo="" from="" includes="" kω="" leakage="" mode<="" pull="" resister="" td="" to="" typical="" vdd.=""></vout<0.9vdd.>
Input Capacitance	CIN	-	-	5	pF	DCTC-MO mode

Notes:

2. APR = PR - initial tolerance - 20-year aging - frequency stability over temperature. Refer to Table 17 for APR with respect to other pull rage options.



# Table 4. Jitter & Phase Noise - LVCMOS

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition			
Jitter									
RMS Phase Jitter (random)	T_phj	_	0.31	0.48	ps	F_nom = 10 MHz Integration bandwidth = 12 kHz to 5 MHz			
RMS Phase Sitter (random)	т_рпј	_	0.31	0.48	ps	F_nom = 50 MH Integration bandwidth = 12 kHz to 20 MHz			
RMS Period Jitter	T_jitt	-	0.8	1.1	ps	F_nom = 10 MHz, population 10k			
Peak Cycle-to-Cycle Jitter	T_jitt_cc	-	6	9	ps	F_nom = 10 MHz, population 1k measured as absolute value			
			Ph	ase Noise					
1 Hz offset		-	-80	-74	dBc/Hz				
10 Hz offset		-	-108	-102	dBc/Hz				
100 Hz offset		-	-127	-123	dBc/Hz				
1 kHz offset		-	-148	-145	dBc/Hz	F_nom = 10 MHz			
10 kHz offset		-	-154	-151	dBc/Hz	TC-MO and DCTC-MO modes, and VCTC-MO mode with ±6.25 ppm pull range			
100 kHz offset		-	-154	-150	dBc/Hz				
1 MHz offset		_	-167	-163	dBc/Hz				
5 MHz offset		_	-168	-164	dBc/Hz				
Spurious	T_spur	_	-112	-105	dBc	F_nom = 10 MHz, 1 kHz to 5 MHz offsets			

# Table 5. Jitter & Phase Noise - Clipped Sinewave

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition		
Jitter								
DMC Phase litter (see down)	T nhi	-	0.31	0.45	ps	F_nom = 19.2 MHz Integration bandwidth = 12 kHz to 5 MHz		
RMS Phase Jitter (random)	T_phj	ı	0.31	0.48	ps	F_nom = 60 MHz Integration bandwidth = 12 kHz to 20 MHz		
			Ph	nase Noise				
1 Hz offset		-	-74	-68	dBc/Hz			
10 Hz offset		_	-102	-97	dBc/Hz			
100 Hz offset		_	-121	-117	dBc/Hz			
1 kHz offset		_	-142	-140	dBc/Hz	F_nom = 19.2 MHz		
10 kHz offset		_	-148	-146	dBc/Hz	TC-MO and DCTC-MO modes, and VCTC-MO mode with ±6.25 ppm pull range		
100 kHz offset		_	-149	-145	dBc/Hz			
1 MHz offset		-	-162	-159	dBc/Hz			
5 MHz offset		-	-164	-160	dBc/Hz			
Spurious	T_spur	-	-109	-104	dBc	F_nom = 19.2 MHz, 1 kHz to 5 MHz offsets		



#### **Table 6. Absolute Maximum Limits**

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Test Conditions	Value	Unit
Storage Temperature		-65 to +125	°C
Continuous Power Supply Voltage Range (Vdd)		-0.5 to +4	V
Human Body Model (HBM) ESD Protection	JESD22-A114	2000	V
Soldering Temperature (follow standard Pb-free soldering guidelines)		+260	°C
Junction Temperature <sup>[3]</sup>		+130	°C

#### Note:

### Table 7. Thermal Considerations<sup>[4]</sup>

Package	θJA (°C/W)	θJC, Bottom (°C/W)
Ceramic 5.0 x 3.2 mm <sup>2</sup>	54	15

#### Note:

### Table 8. Maximum Operation Junction Temperature<sup>[5]</sup>

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
+70 °C	+80 °C

#### Note:

5. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

#### **Table 9. Environmental Compliance**

Parameter	Test Conditions	Value	Unit
Mechanical Shock Resistance	MIL-STD-883F, Method 2002	10000	g
Mechanical Vibration Resistance	MIL-STD-883F, Method 2007	70	g
Temperature Cycle	JESD22, Method A104	-	-
Solderability	MIL-STD-883F, Method 2003	-	-
Moisture Sensitivity Level	MSL1 @260°C	-	_

<sup>3.</sup> Exceeding this temperature for an extended period of time may damage the device.

<sup>4.</sup> Measured in still air.



# **Device Configurations and Pin-outs**

### **Table 10. Device Configurations**

Configuration	Pin 1	Pin 5	I <sup>2</sup> C Programmable Parameters
TC-MO	OE/NC	NC	-
VCTC-MO	VC	NC	-
DCTC-MO	OE/NC	A0/NC	Frequency Pull Range, Frequency Pull Value, Output Enable control

### **Pin-out Top Views**

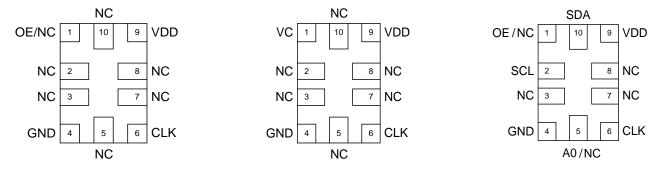


Figure 3. TC-MO

Figure 4. VCTC-MO

Figure 5. DCTC-MO

### **Table 11. Pin Description**

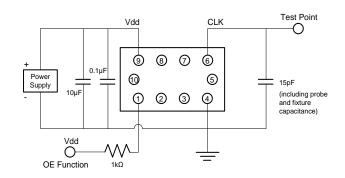
Pin	Symbol	I/O	Internal Pull-up/Pull Down Resistor	Function
		OE – Input	100 kΩ Pull-Up	H <sup>[6]</sup> : specified frequency output L: output is high impedance. Only output driver is disabled
1	OE/NC/VC	NC <sup>[8]</sup> – No Connect	-	H or L or Open: No effect on output frequency or other device functions
		VC – Input	-	Control Voltage in VCTC-MO Mode
2	SCL/NC <sup>[8]</sup>	SCL - Input	200 kΩ Pull-Up	I <sup>2</sup> C Serial Clock Input
2	SCL/NC <sup>1-3</sup>	NC – No Connect	-	H or L or Open: No effect on output frequency or other device functions
3	NC <sup>[8]</sup>	No Connect	-	H or L or Open: No effect on output frequency or other device functions
4	GND	Power	-	Connect to ground
5	A0/NC <sup>[8]</sup> A0 – Input		100 kΩ Pull-Up	Device I <sup>2</sup> C address when the address selection mode is via the A0 pin. This pin is NC when the I <sup>2</sup> C device address is specified in the ordering code.  A0 Logic Level I <sup>2</sup> C Address 0 1100010 1 1101010
		NC – No Connect	-	H or L or Open: No effect on output frequency or other device functions
6	CLK	Output	-	LVCMOS, or clipped sinewave oscillator output
7	NC <sup>[8]</sup>	No Connect	-	H or L or Open: No effect on output frequency or other device functions
8	NC <sup>[8]</sup>	No Connect	-	H or L or Open: No effect on output frequency or other device functions
9	VDD	Power	-	Connect to VDD <sup>[7]</sup>
10		SDA – Input/Output	200 kΩ Pull-Up	I <sup>2</sup> C Serial Data.
10	SDA/NC <sup>[7]</sup>	NC - No Connect	-	H or L or Open: No effect on output frequency or other device functions

#### Notes:

- 6. In OE mode for noisy environments, a pull-up resistor of 10  $k\Omega$  or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- 7. 0.1  $\mu$ F capacitor in parallel with a 10  $\mu$ F capacitor are required between Vdd and GND. The 0.1  $\mu$ F capacitor is recommended to place close to the device, and place the 10  $\mu$ F capacitor less than 2 inches away.
- 8. All NC pins can be left floating and do not be soldered down.



# **Test Circuit Diagrams for LVCMOS and Clipped Sinewave Outputs**



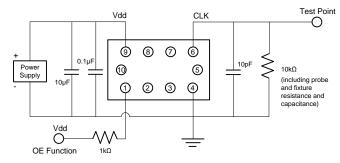


Figure 6. LVCMOS Test Circuit (OE Function)

Figure 6. LVCMOS Test Circuit (OE Function)

Test Point Vdd CLK  $\cap$ 9 8 7 6 Power Supply 10 (5) 15pF (including probe 1 2 3 4 and fixture capacitance) Control Voltage

Figure 8. LVCMOS Test Circuit (VC Function)

VC Function



Figure 7. Clipped Sinewave Test Circuit (OE Function)

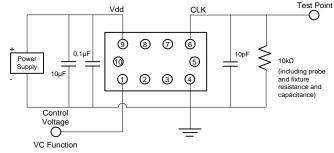


Figure 9. Clipped Sinewave Test Circuit (VC Function) for AC and DC Measurements

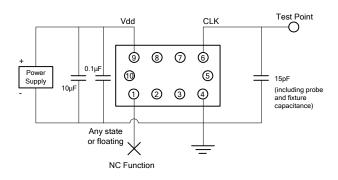


Figure 10. LVCMOS Test Circuit (NC Function)

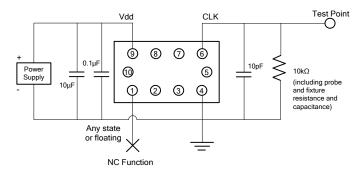


Figure 11. Clipped Sinewave Test Circuit (NC Function) for AC and DC Measurements



# Test Circuit Diagrams for LVCMOS and Clipped Sinewave Outputs (continued)

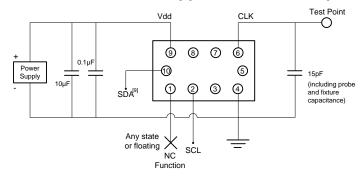


Figure 12. LVCMOS Test Circuit (I<sup>2</sup>C Control), DCTC-MO mode

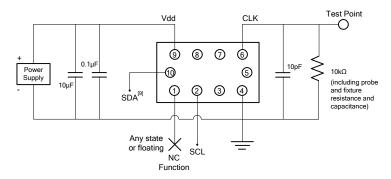


Figure 13. Clipped Sinewave Test Circuit (I<sup>2</sup>C Control), DCTC-MO mode for AC and DC Measurements

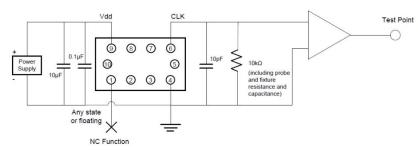


Figure 14. Clipped Sinewave Test Circuit for Phase Noise Measurements, Applies to All Configurations (NC Function shown for example only)

#### Notes:

9. SDA is open-drain and may require pull-up resistor if not present in I<sup>2</sup>C test setup.



### **Waveforms**

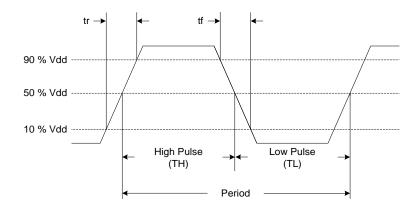


Figure 15. LVCMOS Waveform Diagram<sup>[10]</sup>

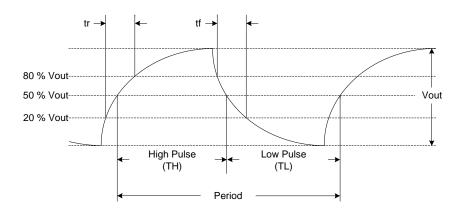
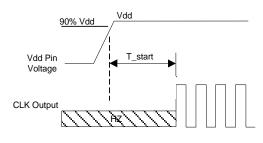


Figure 16. Clipped Sinewave Waveform Diagram<sup>[10]</sup>

#### Notes

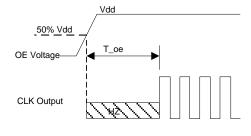
10. Duty Cycle is computed as Duty Cycle = TH/Period.

# **Timing Diagrams**



T\_start: Time to start from power-off

Figure 17. Startup Timing



T\_oe: Time to re-enable the clock output

Figure 18. OE Enable Timing (OE Mode Only)



# **Typical Performance Plots**



Figure 19. ADEV

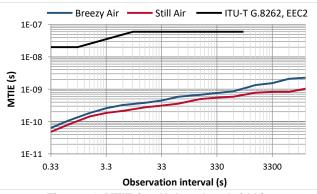


Figure 21. MTIE (0.1 Hz loop bandwidth)

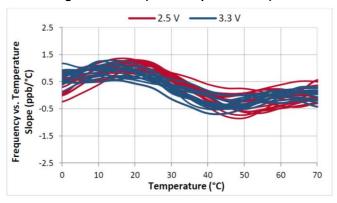


Figure 23. Freq. vs. Temp. Slope (ΔF/ΔT)

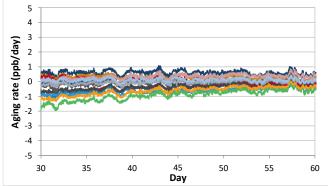


Figure 25. 1-day aging rate (to 62 days)

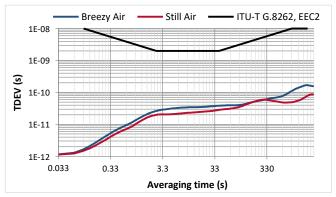


Figure 20. TDEV (0.1 Hz loop bandwidth)

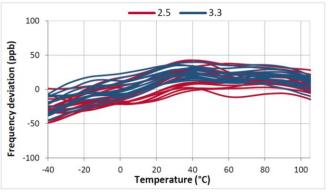


Figure 22. Frequency vs Temperature

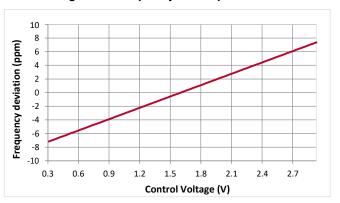


Figure 24. VCTC-MO frequency pull characteristic

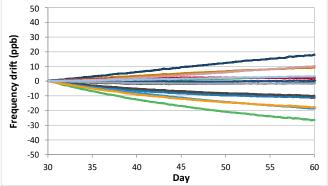
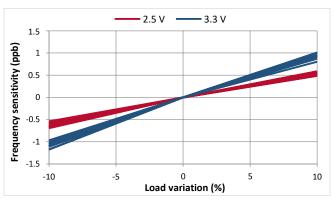


Figure 26. Drift over 30 days relative to the first reading



# Typical Performance Plots (continued)



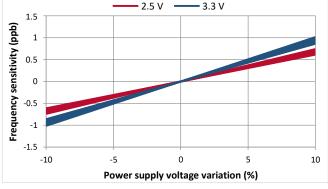
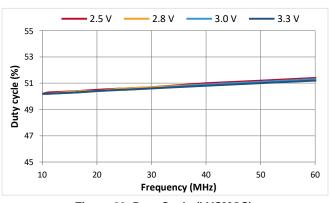


Figure 27. Load sensitivity

Figure 28. VDD sensitivity



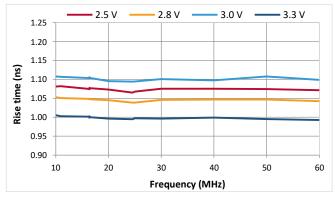
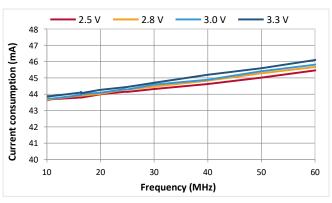


Figure 29. Duty Cycle (LVCMOS)

Figure 30. Rise Time (LVCMOS)



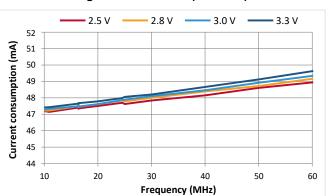
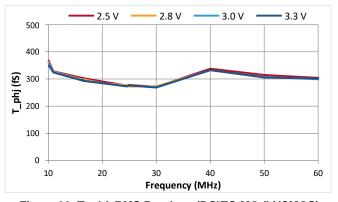


Figure 31. IDD TC-MO (LVCMOS)

Figure 32. IDD VCTC-MO (LVCMOS)



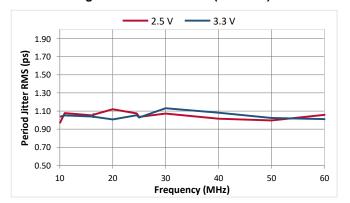


Figure 33. T\_phj, RMS Random, (DC)TC-MO (LVCMOS)

Figure 34. Period Jitter, RMS (LVCMOS)



# Typical Performance Plots (continued)

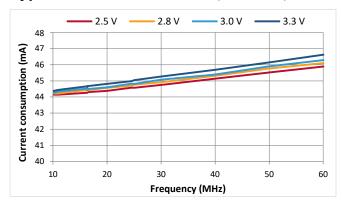


Figure 35. IDD DCTC-MO (LVCMOS)

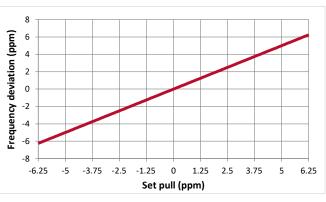


Figure 37. DCTC-MO frequency pull characteristic

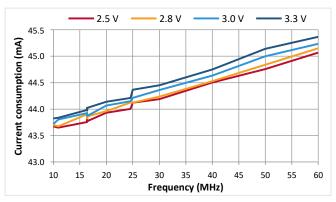


Figure 39. IDD TC-MO (Clipped Sinewave)

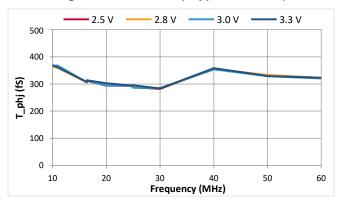


Figure 41. T\_phj, RMS Random, (DC)TC-MO (Clipped Sine)

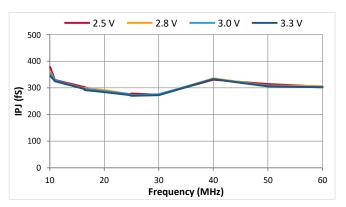


Figure 36. T\_phj, RMS Random, VCTC-MO (LVCMOS)

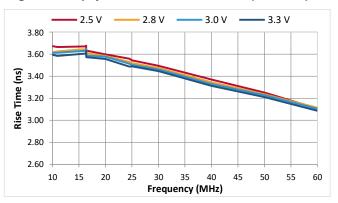


Figure 38. Rise Time (Clipped Sinewave)

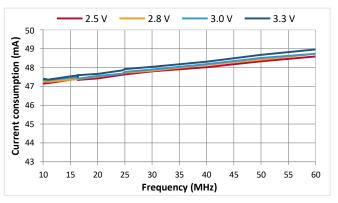


Figure 40. IDD VCTC-MO (Clipped Sinewave)

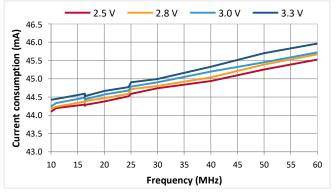
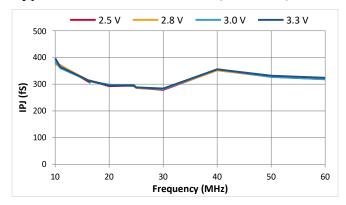


Figure 42. IDD DCTC-MO (Clipped Sinewave)



# Typical Performance Plots (continued)



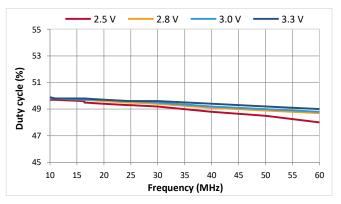


Figure 43. T\_phj, RMS Random, VCTC-MO (Clipped Sine)

Figure 44. Duty Cycle (Clipped Sinewave)



### **Architecture Overview**

Based on KDS's innovative Elite Platform, the MO5358 delivers exceptional dynamic performance, i.e. resilience to environmental stressors such as shock, vibration and fast temperature transients. Underpinning the Elite platform are KDS's unique DualMEMS temperature sensing architecture and TurboCompensation technologies.

DualMEMS is a noiseless temperature compensation scheme. It consists of two MEMS resonators fabricated on the same die substrate. The TempFlat resonator is designed with a flat frequency characteristic over temperature whereas the temperature sensing resonator is by design sensitive to temperature changes. The ratio of frequencies between these two resonators provides an accurate reading of the resonator temperature with 20  $\mu K$  resolution.

By placing the two MEMS resonators on the same die, this temperature sensing scheme eliminates the thermal lag and gradients between the resonator and the temperature sensor, thereby overcoming an inherent weakness of the legacy quartz TCXOs.

The DualMEMS temperature sensor drives a state-of-theart CMOS temperature compensation circuit. The TurboCompensation design, with >100 Hz compensation bandwidth, achieves a dynamic frequency stability that is far superior to any quartz TCXO. The digital temperature compensation enables additional optimization of frequency stability and frequency slope over temperature within any chosen temperature range for a given system design.

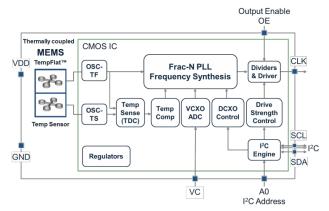


Figure 45. Elite Architecture

The Elite platform also incorporates a high resolution, low noise frequency synthesizer along with the industry standard I<sup>2</sup>C bus. This unique combination enables system designers to digitally control the output frequency in steps as low as 5 ppt and over a wide range up to ±3200 ppm.

For more information regarding the Elite platform and its benefits please contact KDS.

#### **Functional Overview**

The MO5358 is designed for maximum flexibility with an array of factory programmable options, enabling system designers to configure this precision device for optimal performance in a given application.

#### Frequency Stability

The MO5358 comes in one factory-trimmed stability grade.

Table 12. Stability Grades vs. Ordering Codes

Frequency Stability Over Temperature	Ordering Code
±50 ppb	3

### **Output frequency and format**

The MO5358 can be factory programmed for an output frequency without sacrificing lead time or incurring an upfront customization cost typically associated with custom-frequency quartz TCXOs.

The device supports both LVCMOS and clipped sinewave output. Ordering codes for the output format are shown below:

Table 13. Output Formats vs. Ordering Codes

Output Format	Ordering Code
LVCMOS	"C"
Clipped Sinewave	"၂"

#### **Output Frequency Tuning**

In addition to the non-pullable TC-MO, the MO5358 can also support output frequency tuning through either an analog control voltage (VCTC-MO), or  $\rm l^2C$  interface (DCTC-MO). The  $\rm l^2C$  interface enables 16 factory programmed pull-range options from  $\pm 6.25$  ppm to  $\pm 3200$  ppm. The pull range can also be reprogrammed via  $\rm l^2C$  to any supported pull-range value.

Refer to Device Configuration section for details.



### Pin 1 Configuration (OE, VC, or NC)

Pin 1 of the MO5358 can be factory-programmed to support three modes: Output Enable (OE), Voltage Control (VC) or No Connect (NC).

**Table 2. Pin Configuration Options** 

Pin 1 Configuration	Operating Mode	Output
OE	TC-MO/DCTC-MO	Active or High-Z
NC	TC-MO/DCTC-MO	Active
VC	VCTC-MO	Active

When pin 1 configured as OE pin, the device output is guaranteed to operate in one of the following two states:

- Clock output with the frequency specified in the part number when Pin 1 is pulled to logic high
- Hi-Z mode with weak pull down when pin 1 is pulled to logic low.

When pin 1 is configured as NC, the device is guaranteed to output the frequency specified in the part number at all times, regardless of the logic level on pin 1.

In the VCTC-MO configuration, the user can fine-tune the output frequency from the nominal frequency specified in the part number by varying the pin 1 voltage. The guaranteed allowable variation of the output frequency is specified as pull range. A VCTC-MO part number must contain a valid pull-range ordering code.

# **Device Configurations**

The MO5358 supports 3 device configurations – TC-MO, VCTC-MO and DCTC-MO. The TC-MO and VCTC-MO options are directly compatible with the quartz TCXO and VCTCXO. The DCTC-MO configuration provides performance enhancement by eliminating VCTC-MO's sensitivity to control voltage noise with an I<sup>2</sup>C digital interface for frequency tuning.

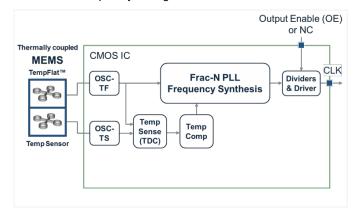


Figure 46. Block Diagram - TC-MO

#### **TC-MO Configuration**

The TC-MO configuration generates a fixed frequency output, as shown in Figure 46. The frequency is specified by the user in the frequency field of the device ordering code and then factory programmed. Other factory programmable options include supply voltage, output types (LVCMOS or clipped sinewave), and pin 1 functionality (OE or NC).

Refer to the ordering information section at the end of the datasheet for a list of all ordering options.



### **VCTC-MO Configuration**

A VCTC-MO, shown in Figure 47, is a frequency control device whose output frequency is an approximately linear function of control voltage applied to the voltage control pin. VCTC-MOs have a number of use cases including the VCO portion of a jitter attenuation/jitter cleaner PLL Loop.

The MO5358 achieves a 10x better pull range linearity of <0.5% via a high-resolution fractional PLL compared with 5% to 10% typical of quartz VCTCXOs that rely on pulling a resonator. By contrast, quartz-based VCTCXOs change output frequency by varying the capacitive load of a crystal resonator using varactor diodes, which results in poor linearity.

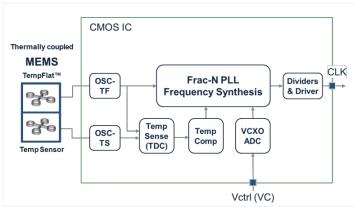


Figure 47. Block Diagram - VCTC-MO

Note that the output frequency of the VCTC-MO is proportional to the analog control voltage applied to pin 1. Because this control signal is analog and directly controls the output frequency, care must be taken to minimize noise on this pin.

The nominal output frequency is factory programmed per the customer's request to 6 digits of precision and is defined as the output frequency when the control voltage equals Vdd/2. The maximum output frequency variation from this nominal value is set by the pull range, which is also factory programmed to the customer's desired value and specified by the ordering code. The Ordering Information section shows all ordering options and associated ordering codes.

Refer to VCTCXO-Specific Design Considerations for more information on critical VCTC-MO parameters including pull range linearity, absolute pull range, control voltage bandwidth, and Kv.



#### **DCTC-MO Configuration**

The MO5358 offers digital control of the output frequency, as shown in Figure 48. The output frequency is controlled by writing frequency control words over the I<sup>2</sup>C interface.

There are several advantages of DCTC-MOs relative to VCTC-MOs:

- Frequency control resolution as low as 5 ppt. This high resolution minimizes accumulated time error in synchronization applications.
- Lower system cost A VCTC-MO may need a Digital to Analog Converter (DAC) to drive the control voltage input. In a DCTC-MO, the frequency control is achieved digitally by register writes to the control registers via I<sup>2</sup>C, thereby eliminating the need for a DAC.
- 3) Better noise immunity The analog signal used to drive the voltage control pin of a VCTC-MO can be sensitive to noise and the trace over which the signal is routed can be susceptible to noise coupling from the system. The DCTC-MO does not suffer from analog noise coupling since the frequency control is performed digitally through I<sup>2</sup>C.

- 4) No frequency pull non-linearity The frequency pulling is achieved via fractional feedback divider of the PLL, eliminating any pull non-linearity concerns typical of quartz based VCTCXOs. This improves dynamic performance in closed-loop operations.
- 5) Programmable wide pull range The DCTC-MO pulling mechanism is via the fractional feedback divider and is therefore not constrained by resonator pullability as in quartz based solutions. The MO5358 offers 16 frequency pull range options from ±6.25ppm to ±3200ppm, providing system designers great flexibility.

Refer to DCTCMO-Specific Design Considerations for more information on critical DCTC-MO parameters including pull range, absolute pull range, frequency output, and I<sup>2</sup>C control registers.

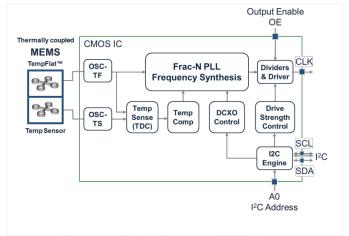


Figure 48. Block Diagram - DCTC-MO



### **VCTC-MO-Specific Design Considerations**

#### Linearity

In any VCTC-MO, there will be some deviation of the frequency-voltage (FV) characteristic from an ideal straight line. Linearity is the ratio of this maximum deviation to the total pull range, expressed as a percentage. Figure 49 below shows the typical pull linearity of a KDS VCTC-MO. The linearity is excellent (1% maximum) relative to most quartz offerings because the frequency pulling is achieved with a PLL rather than varactor diodes.

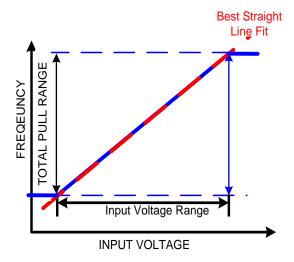


Figure 49. Typical KDS VCTC-MO Linearity

### **Control Voltage Bandwidth**

Control voltage bandwidth, sometimes called "modulation rate" or "modulation bandwidth", indicates how fast a VCO can respond to voltage changes at its input. The ratio of the output frequency variation to the input voltage variation, previously denoted by Kv, has a low-pass characteristic in most VCTC-MOs. The control voltage bandwidth equals the modulating frequency where the output frequency deviation equals 0.707 (e.g. -3 dB) of its DC value, for DC inputs swept in the same voltage range.

For example, a part with a  $\pm 6.25$  ppm pull range and a 0-3V control voltage can be regarded as having an average KV of 4.17 ppm/V (12.5 ppm/3V = 4.17 ppm/V). Applying an input of +1.5V DC  $\pm$  0.5V (+1.0 V to +2.0V) causes an output frequency change of 4.17 ppm ( $\pm 2.08$  ppm). If the control voltage bandwidth is specified as 10 kHz, the peak-to-peak value of the output frequency change will be reduced to 4.33 ppm/ $\sqrt{2}$  or 2.95 ppm, as the frequency of the control voltage change is increased to 10 kHz.

### FV Characteristic Slope K<sub>V</sub>

The slope of the FV characteristic is a critical design parameter in many low bandwidth PLL applications. The slope is the derivative of the FV characteristic – the deviation of frequency divided by the control voltage change needed to produce that frequency deviation, over a small voltage span, as shown below:

$$K_{V} = \frac{\Delta f_{out}}{\Delta V_{in}}$$

It is typically expressed in kHz/Volt, MHz/Volt, ppm/Volt, or similar units. This slope is usually called "Kv" based on terminology used in PLL designs.

The extreme linear characteristic of the KDS MO5358 VCTC-MO family means that there is very little K $_{\rm V}$  variation across the whole input voltage range (typically <1%), significantly reducing the design burden on the PLL designer. Figure 50 below illustrates the typical K $_{\rm V}$  variation.

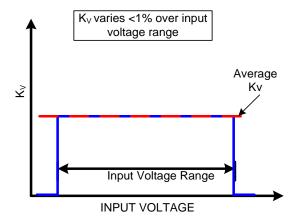


Figure 50. Typical KDS K<sub>V</sub> Variation



# Pull Range, Absolute Pull Range

Pull range (PR) is the amount of frequency deviation that will result from changing the control voltage over its maximum range under nominal conditions.

Absolute pull range (APR) is the guaranteed controllable frequency range over all environmental and aging conditions. Effectively, it is the amount of pull range remaining after taking into account frequency stability tolerances over variables such as temperature, power supply voltage, and aging, i.e.:

$$APR = PR - F_{\text{stability}} - F_{\text{aging}}$$

where  $F_{\text{stability}}$  is the device frequency stability due to initial tolerance and variations on temperature, power supply, and load.

Figure 51 shows a typical KDS VCTC-MO FV characteristic. The FV characteristic varies with conditions, so that the frequency output at a given input voltage can vary by as much as the specified frequency stability of the VCTC-MO. For such VCTC-MOs, the frequency stability and APR are independent of each other. This allows very wide range of pull options without compromising frequency stability.

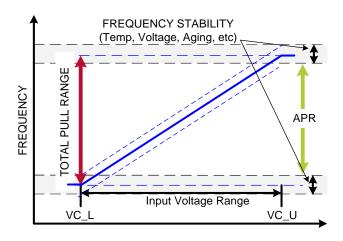


Figure 51. Typical KDS VCTC-MO FV Characteristic

The upper and lower control voltages are the specified limits of the input voltage range as shown on Figure 51 above. Applying voltages beyond the upper and lower voltages do not result in noticeable changes of output frequency. In other words, the FV characteristic of the VCTC-MO saturates beyond these voltages. Figures 1 and 2 show these voltages as Lower Control Voltage (VC\_L) and Upper Control Voltage (VC\_U).

Table 15 below shows the pull range and corresponding APR values for each of the frequency vs. temperature ordering options.

Table 15. VCTC-MO Pull Range, APR Options<sup>[11]</sup>
Typical unless specified otherwise. Pull range (PR) is ±6.25 ppm.

Pull Range Ordering Code	Device Option(s)	APR ppm ±50 ppb option ±0.5 ppm 20-year aging
Т	VCTC-MO	±5.2

#### Notes:

<sup>11.</sup> APR includes ±1 ppm solder down shift, frequency stability vs. temperature, and the corresponding 20-year aging.



# **DCTCXO-Specific Design Considerations**

# Pull Range and Absolute Pull Range

Pull range and absolute pull range are described in the previous section. Table 16 below shows the pull range and corresponding APR values for each of the frequency vs. temperature ordering options.

Table 16. APR Options<sup>[12]</sup>

Pull Range Ordering Code	Pull Range ppm	APR ppm ±0.1 ppm option ±0.5 ppm 20-year aging				
Т	±6.25	±5.2				
R	±10	±8.95				
Q	±12.5	±11.45				
M	±25	±23.95				
В	±50	±48.95				
С	±80	±78.95				
E	±100	±98.95				
F	±125	±123.95				
G	±150	±148.95				
Н	±200	±198.95				
Х	±400	±398.95				
L	±600	±598.95				
Y	±800	±798.95				
S	±1200	±1198.95				
Z	±1600	±1598.95				
U	±3200	±3198.95				

#### Notes:

<sup>12.</sup> APR includes initial tolerance, frequency stability vs. temperature, and the corresponding 20-year aging.



#### **Output Frequency**

The device powers up at the nominal operating frequency and pull range specified by the ordering code. After power- up both pull range and output frequency can be controlled via I<sup>2</sup>C writes to the respective control registers. The maximum output frequency change is constrained by the pull range limits.

The pull range is specified by the value loaded in the digital pull-range control register. The 16 pull range choices are specified in the control register and range from ±6.25ppm to ±3200ppm.

Table 17 below shows the frequency resolution versus pull range programmed value

Table 17. Frequency Resolution vs. Pull Range

Programmed Pull Range	Frequency Resolution
±6.25ppm	5x10 <sup>-12</sup>
±10ppm	5x10 <sup>-12</sup>
±12.5ppm	5x10 <sup>-12</sup>
±25ppm	5x10 <sup>-12</sup>
±50ppm	5x10 <sup>-12</sup>
±80ppm	5x10 <sup>-12</sup>
±100ppm	5x10 <sup>-12</sup>
±120ppm	5x10 <sup>-12</sup>
±150ppm	5x10 <sup>-12</sup>
±200ppm	5x10 <sup>-12</sup>
±400ppm	1x10 <sup>-11</sup>
±600ppm	1.4x10 <sup>-11</sup>
±800ppm	2.1x10 <sup>-11</sup>
±1200ppm	3.2x10 <sup>-11</sup>
±1600ppm	4.7x10 <sup>-11</sup>
±3200ppm	9.4x10 <sup>-11</sup>

The ppm frequency offset is specified by the 26 bit DCXO frequency control register in two's complement format as described in the I²C Register Descriptions. The power up default value is 000000000000000000000000000 which sets the output frequency at its nominal value (0 ppm). To change the output frequency, a frequency control word is written to 0x00[15:0] (Least Significant Word) and 0x01[9:0] (Most Significant Word). The LSW value should be written first followed by the MSW value; the frequency change is initiated after the MSW value is written.



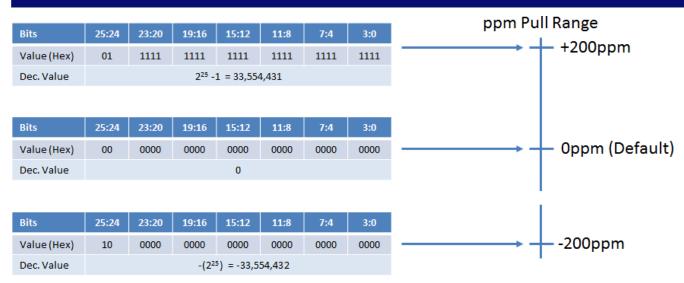


Figure 52 Pull range and Frequency Control Word

Figure 52 shows how the two's complement signed value of the frequency control word sets the output frequency within the ppm pull range set by 0x02:[3:0]. This example shows use of the ±200 ppm pull range. Therefore, to set the desired output frequency, one just needs to calculate the fraction of full scale value ppm, convert to two's complement binary and then write the values to the frequency control registers.

The following formula generates the control word value:

Control word Value = RND(( $2^{25}$ -1) x ppm shift from nominal/pull range), where RND is the rounding function which rounds the number to the nearest whole number. Two examples follow, assuming the  $\pm 200$  ppm pull range:

#### Example 1:

- Default Output Frequency = 19.2 MHz
- Desired Output Frequency = 19.201728 MHz (+90 ppm)

 $2^{25}$ -1 corresponds to +200 ppm, and the fractional value required for +90 ppm can be calculated as follows.

 $\blacksquare$  90 ppm / 200 ppm x (2<sup>25</sup>-1) = 15,099,493.95.

Rounding to the nearest whole number yields 15,099,494 and converting to two's complement gives a binary value of 111001100110011001100110 and E66666 in hex.

#### Example 2:

- Default Output Frequency = 10 MHz
- Desired Output Frequency = 9.998 MHz (-50 ppm)

Following the formula shown above,

 $\blacksquare$  (-50 ppm / 200 ppm) x (2<sup>25</sup>-1) = -8,388,607.75.

Rounding this to the nearest whole number results in -8,388,608.

To summarize, the procedure for calculating the frequency control word associated with a given ppm offset is as follows:

- Calculate the fraction of the half pull range needed. For example, if the total pull range is set for ±100 ppm and a +20 ppm shift from the nominal frequency is needed, this fraction is 20 ppm/100 ppm = 0.2
- 2) Multiply this fraction by the full half scale word value,  $2^{25}$ -1 = 33,554,431, round to the nearest whole number and convert the result to two's complement binary. Following the +20ppm example, this value is 0.2 x 33,554,431 = 6,710,886.2 and rounded to 6,710,886.
- Write the two's complement binary value starting with the Least Significant Word (LSW) 0x00[16:0], followed by the Most Significant Word (MSW), 0x01[9:0]. If the user desires that the output remains enabled while changing the frequency, a 1 must also be written to the OE control bit 0x01[10] if the device has software OE Control Enabled.

It is important to note that the maximum Digital Control update rate is 38 kHz regardless of I<sup>2</sup>C bus speed.



# I<sup>2</sup>C Control Registers

The MO5358 enables control of frequency pull range, frequency pull value, and Output Enable via I<sup>2</sup>C writes to the control registers. Table 18 below shows the register map summary, and detailed register descriptions follow.

### **Table 18. Register Map Summary**

Address	Bits	Access	Description
0x00	[15:0]	RW	DIGITAL FREQUENCY CONTROL LEAST SIGNIFICANT WORD (LSW)
0x01	[15:11]	R	NOT USED
	[10]	RW	OE Control. This bit is only active if the output enable function is under software control. If the device is configured for hardware control using the OE pin, writing to this bit has no effect.
	[9:0]	RW	DIGITAL FREQUENCY CONTROL MOST SIGNIFICANT WORD (MSW)
0x02	[15:4]	R	NOT USED
	[3:0]	RW	DIGITAL PULL RANGE CONTROL

# **Register Descriptions**

# Register Address: 0x00. Digital Frequency Control Least Significant Word (LSW)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Access	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW
Default	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Name		DIGITAL FREQUENCY CONTROL LEAST SIGNIFICANT WORD (LSW)[15:0]														

Bits	Name	Access	Description
15:0	DIGITAL FREQUENCY CONTROL LEAST SIGNIFICANT WORD	RW	Bits [15:0] are the lower 16 bits of the 26 bit FrequencyControlWord and are the Least Significant Word (LSW). The upper 10 bits are in regsiter 0x01[9:0] and are the Most Significant Word (MSW). The lower 16 bits together with the upper 10 bits specify a 26-bit frequency control word.  This power-up default values of all 26 bits are 0 which sets the output frequency at its nominal value. After power-up, the system can write to these two registers to pull the frequency across the pull range. The register values are two's complement to support positive and negative control values. The LSW value should be written before the MSW value because the frequency change is initiated when the new values are loaded into the MSW. More details and examples are discussed in the next section.



# Register Address: 0x01. OE Control, Digital Frequency Control Most Significant Word (MSW)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Access	R	R	R	R	R	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW	RW
Default	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Name		N	IOT USE	D		OE			DC-	MO FRE	QUENCY	CONTRO	DL[9:0] M	SW		

Bits	Name	Access	Description						
15:11	NOT USED	R	Bits [15:10] are read only and return all 0's when read. Writing to these bits has no effect.						
10	OE Control	RW	Output Enable Software Control. Allows the user to enable and disable the output driver via I <sup>2</sup> C.						
			0 = Output Disabled (Default)						
			1 = Output Enabled						
			This bit is only active if the Output Enable function is under software control. If the device is configured for hardware control using the OE pin, writing to this bit has no effect.						
9:0	DIGITAL FREQUENCY CONTROL MOST SIGNIFICANT WORD (MSW)	RW	Bits [9:0] are the upper 10 bits of the 26 bit FrequencyControlWord and are the Most Significant Word (MSW). The lower 16 bits are in register 0x00[15:0] and are the Least Significant Word (LSW). These lower 16 bits together with the upper 10 bits specify a 26-bit frequency control word.						
			This power-up default values of all 26 bits are 0 which sets the output frequency at its nominal value. After power-up, the system can write to these two registers to pull the frequency across the pull range. The register values are two's complement to support positive and negative control values. The LSW value should be written before the MSW value because the frequency change is initiated when the new values are loaded into the MSW. More details and examples are discussed in the previous section.						



# Register Address: 0x02. DIGITAL PULL RANGE CONTROL<sup>[13]</sup>

Bit	15	14	13	12	11	10	9	6	5	6	5	4	3	2	1	0
Access	R	R	R	R	R	R	R	R	R	R	R	R	RW	RW	RW	RW
Default	0	0	0	0	0	0	0	0	0	0	0	0	X	Х	Х	Х
Name		NONE									DIGITAL	PULL RA	NGE CO	NTROL		

Notes:
13. Default values are factory set but can be over-written after power-up.

Bits	Name	Access	Description
15:4	NONE	R	Bits [15:4] are read only and return all 0's when read. Writing to these bits has no effect.
3:0	DIGITAL PULL RANGE CONTROL	RW	Sets the digital pull range of the DC-MO. The table below shows the available pull range values and associated bit settings. The default value is factory programmed.
			Bit
			3210
			0 0 0 0: ±6.25ppm
			0 0 0 1: ±10ppm
			0 0 1 0: ±12.5ppm
			0 0 1 1: ±25ppm
			0 1 0 0: ±50ppm
			0 1 0 1: ±80ppm
			0 1 1 0: ±100ppm
			0 1 1 1: ±125ppm
			1 0 0 0: ±150ppm
			1 0 0 1: ±200ppm
			1 0 1 0: ±400ppm
			1 0 1 1: ±600ppm
			1 1 0 0: ±800ppm
			1 1 0 1: ±1200ppm
			1 1 1 0: ±1600ppm
			1 1 1 1: ±3200ppm



# **Serial Interface Configuration Description**

The MO5358 includes an I<sup>2</sup>C interface to access registers that control the DCTC-MO frequency pull range, and frequency pull value. The MO5358 I<sup>2</sup>C slave-only interface supports clock speeds up to 1 MHz. The MO5358 I<sup>2</sup>C module is based on the I<sup>2</sup>C specification, UM1024 (Rev.6 April 4, 2014 of NXP Semiconductor).

## **Serial Signal Format**

The SDA line must be stable during the high period of the SCL. SDA transitions are allowed only during SCL low level for data communication. Only one transition is allowed during the low SCL state to communicate one bit of data. Figure 53 shows the detailed timing diagram.

An idle I<sup>2</sup>C bus state occurs when both SCL and SDA are not being driven by any master and are therefore in a logic HI state due to the pull up resistors. Every transaction begins with a START (S) signal and ends with a STOP (P) signal. A START condition is defined by a high to low transition on the SDA while SCL is high. A STOP condition is defined by a low to high transition on the SDA while SCL is high. START and STOP conditions are always generated by the master. This slave module also supports repeated START (Sr) condition which is same as START condition instead of STOP condition (the blue-color line shows repeated START in Figure 54).

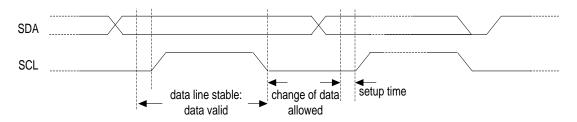


Figure 53. Data and clock timing relation in I<sup>2</sup>C bus

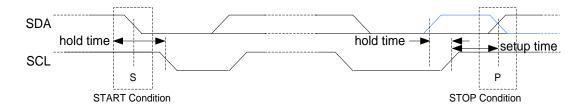


Figure 54. START and STOP (or repeated START, blue line) condition



## **Parallel Signal Format**

Every data byte is 8 bits long. The number of bytes that can be transmitted per transfer is unrestricted. Data is transferred with the MSB (Most Significant Bit) first. The detailed data transfer format is shown in Figure 56 below.

The acknowledge bit must occur after every byte transfer and it allows the receiver to signal the transmitter that the byte was successfully received and another byte may be sent. The acknowledge signal is defined as follows: the transmitter releases the SDA line during the acknowledge clock pulse so the receiver can pull the SDA line low and it remains stable low during the high period of this clock pulse. Setup and hold times must also be taken into account. When SDA remains high during this ninth clock pulse, this is defined as the Not-Acknowledge signal (NACK). The master can then generate either a STOP condition to abort the transfer, or a repeated START condition to start a new transfer. The only condition that leads to the generation of NACK from the MO5358 is when the transmitted address does not match the slave address. When the master is reading data from the MO5358, the MO5358 expects the ACK from the master at the end of received data, so that the slave releases the SDA line and the master can generate the STOP or repeated START. If there is a NACK signal at the end of the data, then the MO5358 tries to send the next data. If the first bit of the next data is "0", then the MO5358 holds the SDA line to "0", thereby blocking the master from generating a STOP/(re)START signal.

### **Parallel Data Format**

This I<sup>2</sup>C slave module supports 7-bit device addressing format. The 8<sup>th</sup> bit is a read/write bit and "0" indicates a read transaction and a "1" indicates a write transaction. The register addresses are 8-bits long with an address range of 0 to 255 (00h to FFh). Auto address incrementing is supported which allows data to be transferred to contiguous addresses without the need to write each address beyond the first address. Since the maximum register address value is 255, the address will roll from 255 back to 0 when auto address incrementing is used. Obviously, auto address incrementing should only be used for writing to contiguous addresses. The data format is 16-bit (two bytes) with the most significant byte being transferred first.

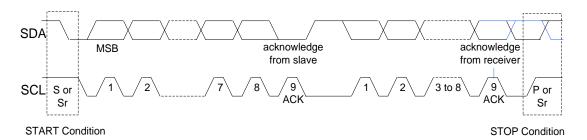


Figure 55. Parallel Signaling Format

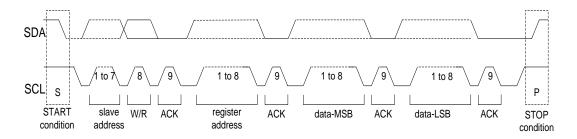


Figure 56. Parallel Data Byte Format



Figure 57 below shows the I<sup>2</sup>C sequence for writing the 4-byte control word using auto address incrementing.

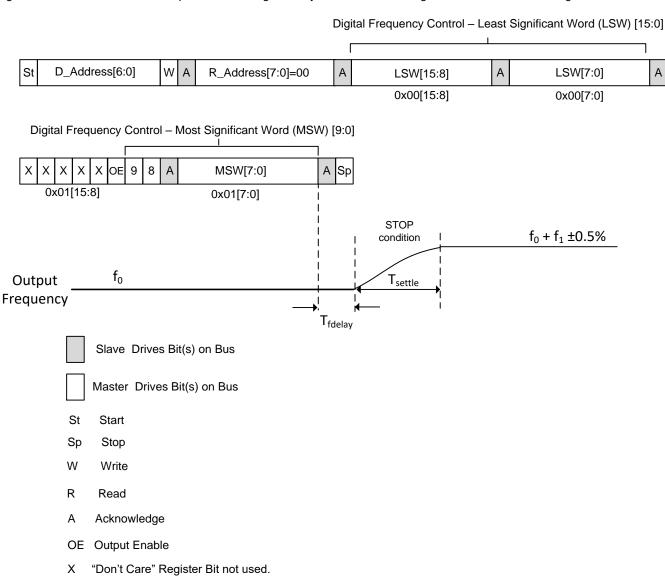


Figure 57. Writing the Frequency Control Word

Table 19. DCTC-MO Delay and Settling Time

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
Frequency Change Delay	T <sub>fdelay</sub>	-	22	-	μsec	
Frequency Settling Time	T <sub>settle</sub>	-	30	-	µsec	Time to settle to 1% of final frequency value



# I<sup>2</sup>C Timing Specification

The below timing diagram and table illustrate the timing relationships for both master and slave.

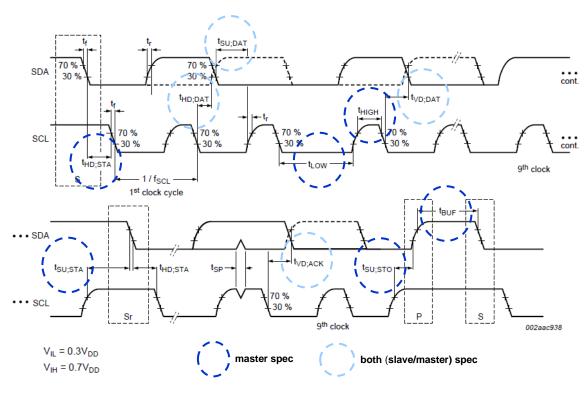


Figure 58. I<sup>2</sup>C Timing Diagram

Table 22. I<sup>2</sup>C Timing Requirements

Parameter	Speed Mode	Value	Unit
tsetup	FM+ (1 MHz)	> 50	nsec
	FM (400KHz)	> 100	nsec
	SM (100KHz)	> 250	nsec
t <sub>HOLD</sub>	FM+ (1 MHz)	> 0	nsec
	FM (400KHz)	> 0	nsec
	SM (100KHz)	> 0	nsec
t <sub>VD:AWK</sub>	FM+	> 450	nsec
	FM (400KHz)	> 900	nsec
	SM (100KHz)	> 3450	nsec
tvd:dat		NA (s-awk + s-data)/(m-awk/s-data)	



# I<sup>2</sup>C Device Address Modes

There are two I<sup>2</sup>C address modes:

- Factory Programmed Mode. The lower 4 bits of the 7-bit device address are set by ordering code as shown in Table 21 below. There are 16 factory programmed addresses available. In this mode, pin 5 is NC and the A0 I<sup>2</sup>C address pin control function is not available.
- A0 Pin Control. This mode allows the user to select between two I<sup>2</sup>C Device addresses as shown in Table 22.

Table 21. Factory Programmed I<sup>2</sup>C Address Control<sup>[14]</sup>

I <sup>2</sup> C Address Ordering Code	Device I <sup>2</sup> C Address
0	1100000
1	1100001
2	1100010
3	1100011
4	1100100
5	1100101
6	1100110
7	1100111
8	1101000
9	1101001
A	1101010
В	1101011
С	1101100
D	1101101
E	1101110
F	1101111

#### Notes:

### Table 22. Pin Selectable I<sup>2</sup>C Address Control<sup>[15]</sup>

A0 Pin 5	I <sup>2</sup> C Address
0	1100010
1	1101010

#### lotes:

<sup>14.</sup> Table 21 is only valid for the DCTC-MO device option which supports  $\mbox{I}^2\mbox{C}$  Control.

Table 22 is only valid for the DCTC-MO device option which supports I<sup>2</sup>C control and A0 Device Address Control Pin.



# **Schematic Example**

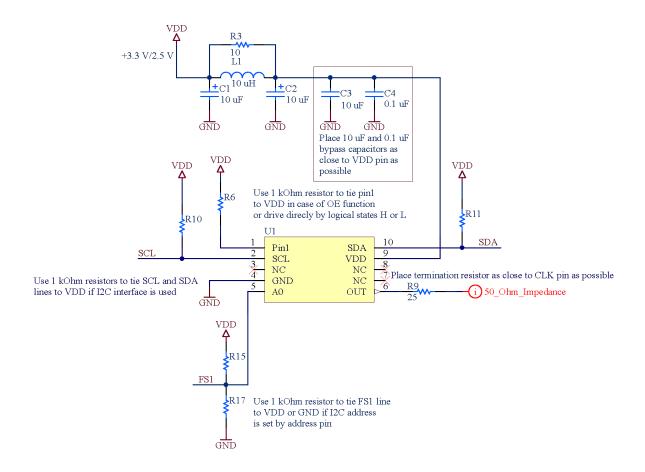
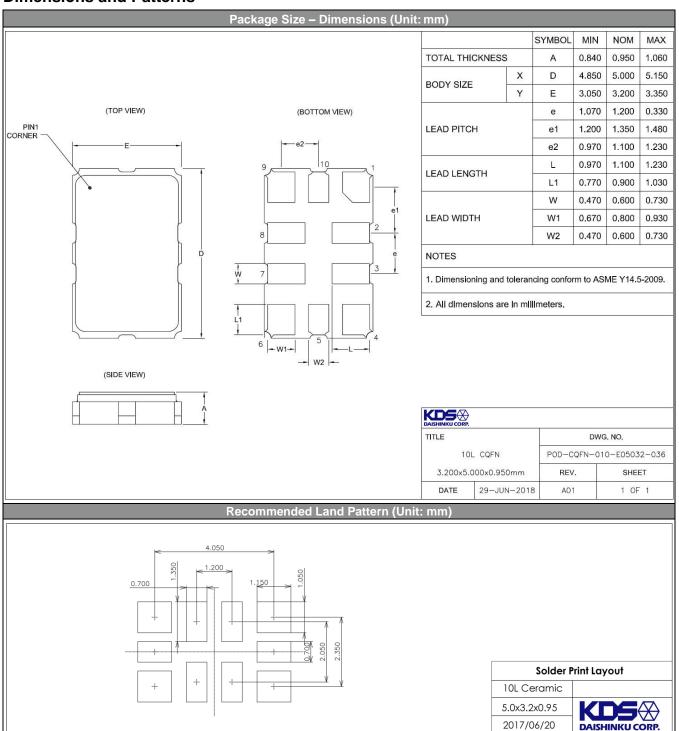


Figure 59. DCTC-MO schematic example



### **Dimensions and Patterns**





## **Layout Guidelines**

- MO5358 uses internal regulators to minimize the impact of the power supply noise. For further reduction of noise, it is essential to use two bypass capacitors (0.1 μF and 10 μF). Place the bypass capacitors as close to the Vdd as possible, typically within 1 to 2 mm. Ensure that the 0.1uF cap is the closest to the device Vdd and GND power pins
- It is also recommended to connect all NC pins to the ground plane and place multiple vias under the GND pin for maximum heat dissipation.
- For additional layout recommendations, contact KDS.

# **Manufacturing Guidelines**

The MO5358 Super-TC-MOs is a precision timing device. **Proper PCB solder and cleaning processes** must be followed to ensure best performance and long-term reliability.

- No Ultrasonic or Megasonic Cleaning: Do not subject the MO5358 to an ultrasonic or megasonic cleaning environment. Otherwise, Permanent damage or long-term reliability issues to the device may result.
- No external cover. Unlike legacy quartz TCXOs, the MO5358 is engineered to operate reliably without performance degradation, in the presence of ambient disturbers such as airflow and sudden temperature changes. Therefore, the use of an external cover typically required by quartz TCXOs is not needed.
- Reflow profile: For mounting these devices to the PCB, IPC/JEDEC J-STD-020 compliant reflow profile must be used. Device performance is not guaranteed if soldered manually or with a non-compliant reflow profile.
- PCB cleaning: after the surface mount (SMT)/reflow process, solder flux residues may be present on the PCB and around the pads of the device. Excess residual solder flux may lead to problems such as pad corrosion, elevate leakage currents, increased frequency aging, or other performance degradation. For optimal device performance and long-term reliability, thorough cleaning and drying of the PCB is required as shortly after the reflow process as possible, even when using a "no clean" flux. Care should be taken to remove all residual flux between the KDS device and the PCB. Note that ultrasonic PCB cleaning should not be used with KDS oscillators.
- For additional manufacturing guidelines and marking/ tape-reel instructions, contact KDS.



# **Table 3. Revision History**

Version	Release Date	Change Summary	
0.1	05/10/2016	First release, advanced information	
0.15	08/04/2016	Replaced QFN package with SOIC-8 package Added 10 µF bypass cap requirement Updated test circuits to reflect both new bypass cap requirement and SOIC-8 package Update Table 1 (Electrical Characteristics)	
0.16	09/12/2016	Updated test circuit diagrams	
0.2	09/21/2016	Revised Table 1 (Electrical Characteristics)	
0.4	12/19/2016	Added DCTC-MO mode Added I2C information Added I2C	
0.5	07/21/2017	Added 5.0x3.2 mm package information Updated Table 1: Electrical Characteristics	
0.51	08/20/2017	Changed to preliminary Updated 5.0x3.2 mm package dimensions Updated test circuits Updated Table 1 (Electrical Characteristics) Updated part ordering info Misc. corrections	
0.52	11/24/2017	Updated the Thermal Characteristics table Added more on Manufacturing Guideline section	
0.55	02/05/2018	Added View labels to Package Drawings Updated the frequency vs. output type changes to 60 MHz Updated links and notes	
0.60	03/01/2018	Added +105°C support, updated Ordering Information	
0.9	07/06/2018	Updated Electrical Characteristics tables. Added Performance Plots. Fixed bad hyperlinks.	
0.91	08/03/2018	Added test circuit for clipped sinewave phase noise Revised phase noise specification. Updated package outline drawing. Updated conditions for one day and one year aging specs. Various formatting updates.	